



FQB50N06 / FQI50N06

60V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

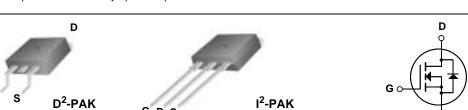
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

FQB Series

Features

- 50A, 60V, $R_{DS(on)} = 0.022\Omega @V_{GS} = 10 V$
- Low gate charge (typical 31 nC)
- · Low Crss (typical 65 pF)
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- 175°C maximum junction temperature rating
- · RoHS Compliant

FQI Series



Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

GDS

Symbol	Parameter		FQB50N06 / FQI50N06	Units
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°C)		50	Α
	- Continuous (T _C = 100°C	()	35.4	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	200	Α
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	490	mJ
I _{AR}	Avalanche Current	(Note 1)	50	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *		3.75	W
	Power Dissipation (T _C = 25°C)		120	W
	- Derate above 25°C		0.8	W/°C
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient			62.5	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 48 V, T _C = 150°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 25 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$		0.018	0.022	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 25 V, I _D = 25 A (Note 4)		22		S
Dynam C _{iss}	ic Characteristics Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1180	1540	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		440	580	pF
C _{rss}	Reverse Transfer Capacitance			65	90	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V 00 V I 05 A		15	40	ns
t _r	Turn-On Rise Time	$V_{DD} = 30 \text{ V}, I_{D} = 25 \text{ A},$ $R_{G} = 25 \Omega$		105	220	ns
t _{d(off)}	Turn-Off Delay Time	NG = 25 12		60	130	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		65	140	ns
Q _g	Total Gate Charge	V _{DS} = 48 V, I _D = 50 A,		31	41	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		8		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		13		nC
	ource Diode Characteristics a		1	1		
l _S	Maximum Continuous Drain-Source Diode Forward Current				50	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F				200	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 50 A			1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = 50 \text{ A,}$		52		ns
Q_{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$ (Note 4)		75		nC

- Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 230μ H, I_{AS} = 50A, V_{DD} = 25V, R_G = 25Ω , Starting T_J = 25° C 3. I_{SD} $\leq 50A$, dl/dt $\leq 300A/\mu$ s, V_{DD} $\leq BV_{DSS}$, Starting T_J = 25° C 4. Pulse Test : Pulse width $\leq 300\mu$ s, Duty cycle $\leq 2\%$ 5. Essentially independent of operating temperature

Typical Characteristics

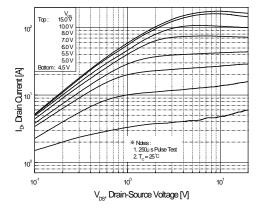


Figure 1. On-Region Characteristics

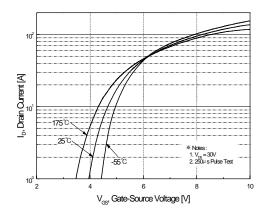


Figure 2. Transfer Characteristics

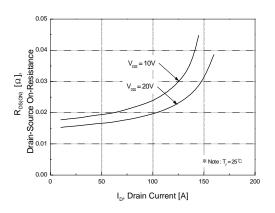


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

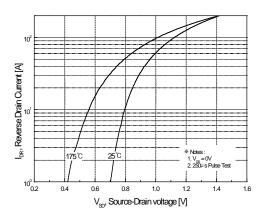


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

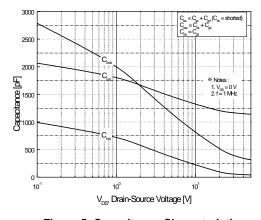


Figure 5. Capacitance Characteristics

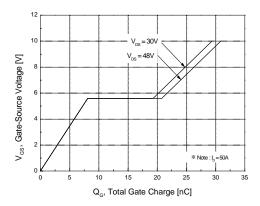
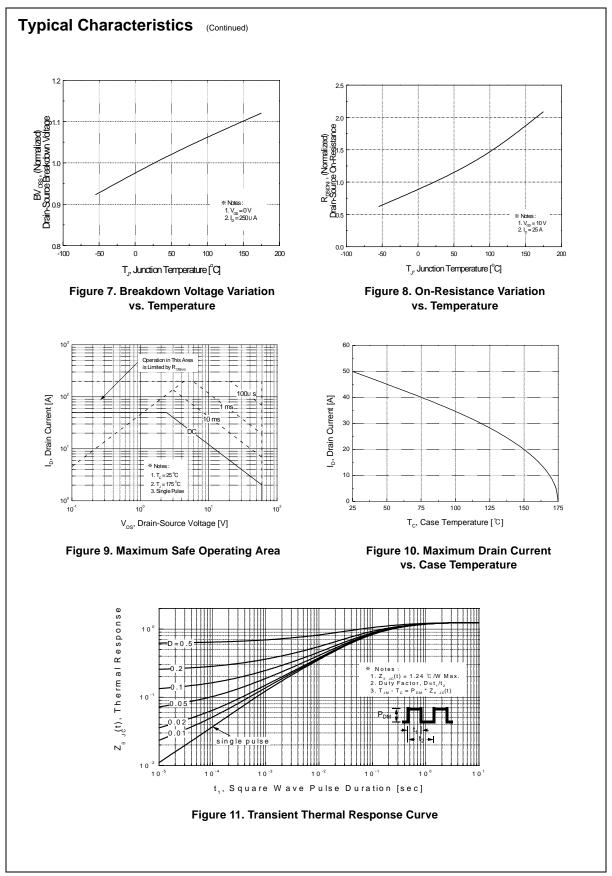
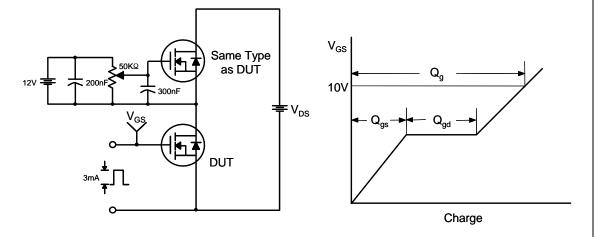


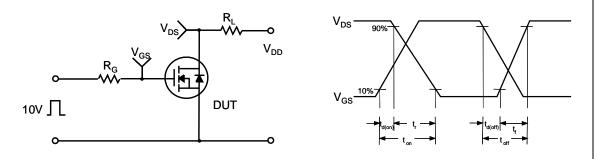
Figure 6. Gate Charge Characteristics



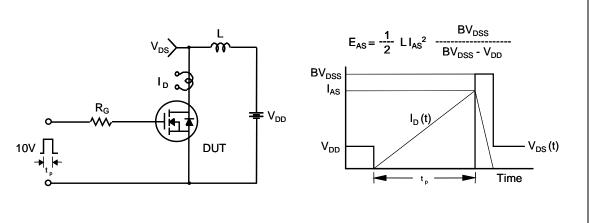




Resistive Switching Test Circuit & Waveforms

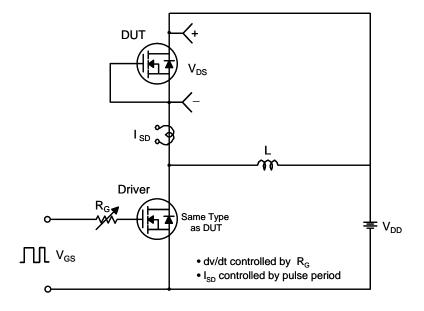


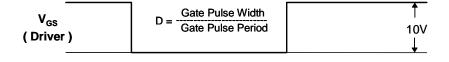
Unclamped Inductive Switching Test Circuit & Waveforms

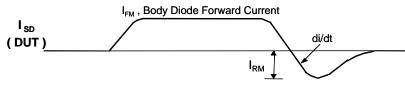


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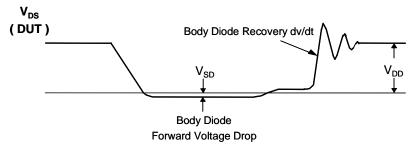
Peak Diode Recovery dv/dt Test Circuit & Waveforms



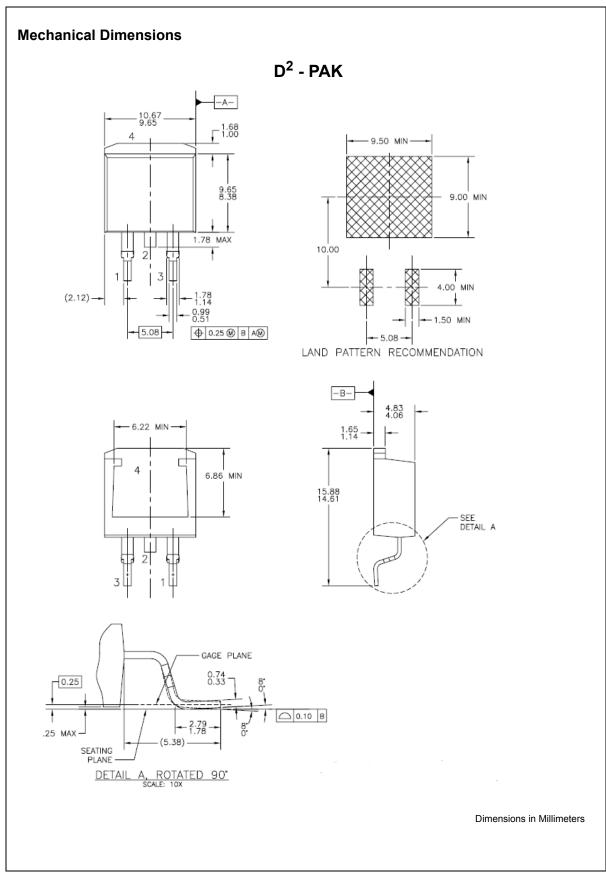




Body Diode Reverse Current

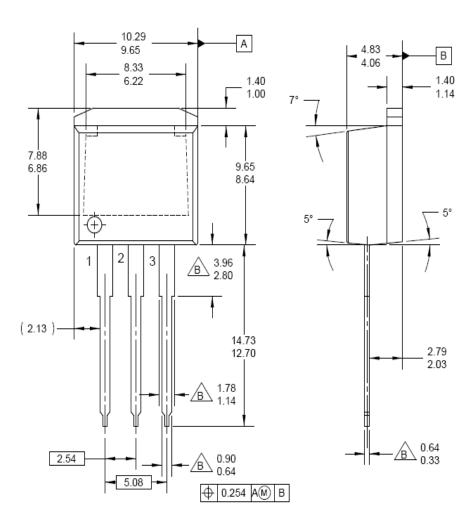


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Mechanical Dimensions

I² - PAK



Dimensions in Millimeters





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